505099526 09/18/2018

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5146286

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
OWEN R. FAY	09/17/2018

RECEIVING PARTY DATA

Name:	MICRON TECHNOLOGY, INC.	
Street Address:	8000 S. FEDERAL WAY	
City:	BOISE	
State/Country:	IDAHO	
Postal Code:	83716	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16134315

CORRESPONDENCE DATA

Fax Number: (208)562-4901

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2085624900

Email: instructions@parsonsbehle.com

Correspondent Name: PARSONS BEHLE & LATIMER PARSONS BEHLE &

Address Line 1: 800 W. MAIN STREET

Address Line 2: SUITE 1300

Address Line 4: BOISE, IDAHO 83702

ATTORNEY DOCKET NUMBER:	05847.072US01	
NAME OF SUBMITTER:	CHRISTOPHER J. CUNEO	
SIGNATURE:	/Christopher J. Cuneo/	
DATE SIGNED:	09/18/2018	

Total Attachments: 1

source=009-05847-072US01_Assignment_exec_2018-0539#page1.tif

PATENT 505099526 REEL: 046900 FRAME: 0611

05847.072US01 *2018-0539*

PATENT APPLICATION ASSIGNMENT

WHEREAS, I, Owen R. Fay, residing at 4083 E. Easy Jet Drive, Meridian, Idaho, 83642 USA have

invented new and useful improvements in INTEGRATED ANTENNA USING THROUGH SILICON VIAS for

which Assignor is making or has made application for LETTERS PATENT OF THE UNITED STATES, which

application has been duly executed by Assignor(s) concurrently herewith;

WHEREAS, Micron Technology, Inc., a corporation organized and existing under and by virtue of

the laws of the State of Delaware, and having an office and place of business at 8000 S. Federal Way,

Boise, Idaho 83716 USA, (hereinafter "Assignee") is desirous of acquiring our entire right, title and interest

in said application and our Letters Patent which may issue thereon.

NOW, THEREFORE, it be known by all whom it may concern that for and in consideration of One

Dollar (\$1.00), the receipt of which is hereby acknowledged, and other good and valuable consideration,

I hereby assign to said corporation, both in and for the territory of the United States of America and the

entire world, all my title and interest in and to said invention, patent application and any patent which

may issue thereon, including all divisions, continuations, reissues, continuations-in-part and substitutions

thereof, plus all priority rights for patent applications foreign to the United States of America. I further

hereby assign and transfer to said corporation whatever cause of action I may have for past or present

infringement of said invention, together with the right to bring suit for any such infringement and to seek

and receive damages and other relief arising from any such infringement.

I HEREBY covenant and agree that I will at any time, upon the request of said corporation, execute

and deliver any and all papers and do all lawful acts that may be necessary or desirable to perfect the title

to said invention, applications and patents, and I authorize the Commissioner of Patents and Trademarks

to issue Letters patent to said corporation.

Inventor

RECORDED: 09/18/2018

Date: 9/17/2018

PATENT

REEL: 046900 FRAME: 0612